PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
ZHENHUAN LUO	01/26/2022
FUQI LIU	01/26/2022

RECEIVING PARTY DATA

Name:	DONGGUAN HAILEX POLYMER MATERIAL SCIENCE AND TECHNOLOGY CO., LTD
Street Address:	ROOM 133,SOUTH PART OF PRODUCTIVITY BUILDING
Internal Address:	SONGSHAN LAKE NATIONAL HIGH-TECH ZONE
City:	DONGGUAN CITY, GUANGDONG PROVINCE
State/Country:	CHINA
Postal Code:	523000

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16172858

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	BZC-USU-A630
NAME OF SUBMITTER:	MEI LIN WONG
SIGNATURE:	/Mei Lin Wong/
DATE SIGNED:	03/14/2022

Total Attachments: 2

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> **PATENT** REEL: 059261 FRAME: 0061

507176958

ASSIGNMENT

WHEREAS Zhenhuan LUO and Fuqi LIU₃, the assignors, whose mailing address is/are: Room 133, South Part of Productivity Building, Songshan Lake National High-Tech Zone, DongGuan City, Guangdong Province, China, P.C.523000,

have invented certain new and useful improvements in an invention relating to and entitled <u>Method of Microcellular Foam Molding</u>, the invention, as fully set forth and described in an application for Letters Patent filed at the United States Patent and Trademark Office on <u>10/29/2018</u> with an application number: <u>16/172,858</u> and naming the assignors as inventors and applicants;

AND WHEREAS <u>DONGGUAN HAILEX POLYMER MATERIAL SCIENCE AND TECHNOLOGY CO., LTD</u> of <u>CHINA</u>, the assignee, whose mailing address is <u>Room 133</u>, <u>South Part of Productivity Building</u>, <u>Songshan Lake National High-Tech Zone</u>, <u>DongGuan City</u>, <u>Guangdong Province</u>, <u>China</u>, P.C.523000,

is desirous of acquiring the entire right, title and interest in and to said invention, and in and to Any Letters Patent that may be obtained therefor;

Assignors and Assignce note and acknowledge that a document in connection with the application number 16/172,858 was recorded at the United States Patent and Trademark Office at Reel/Frame 047334/0123 on 10/29/2018, and that, due to potential defects, the present assignment document is appropriate to memorialize the ownership transfer from Assignors to Assignee;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, receipt of which is hereby acknowledged, the assignors, do hereby confirm that they have sold, assigned and transferred, and do hereby sell, assign and transfer to the assignee the full and exclusive right to the said invention in the United States and their entire right, title and interest for the United States in and to the invention, together with their entire right, title and interest in and to said application, any and all divisional applications thereof, and any and all Letters Patent of the United States which may issue or be reissued for the invention;

AND the assignors hereby authorize and request the Director of the United States Patent and Trademark Office to issue to said assignee of any and all said Letters Patent not already issued as the assignee of their entire right, title and interest in and to the same, for the sole use and benefit of said assignee, its successors, assigns or legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by the assignors had this assignment and sale not been made.

AND the assignors, on behalf of themselves and their executors and administrators, hereby covenant and agree to do all such lawful acts and things and to execute without further consideration such further lawful assignments, documents, assurances, applications, and other instruments as may reasonably be required by said assignee, its successors, assigns or legal representatives, to obtain any and all Letters Patent of the United States for said invention and vest the same in said assignee, its successors, assigns or legal representatives.

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Conti. Assignment

RE: Method of Microcellular Foam Molding

Application number: 16/172,858

For Zhenhuan LUO:

This Assignment may be executed in counterparts and on telecopy counterparts, each of which when so executed shall be deemed to be an original and all of which when taken together shall constitute but one and the same instrument.

Signature: THE PARTY OF THE Name: Zhenhuan LUO	Date Signed: W27. 1. 16
WITNESS:	
Signature: 小儿杨 Name: 同驱杨	Date Signed: 2072 1 26.
For Fuqi LIU:	
Signature:Name: Fuqi LIU J	Date Signed: 2022. 0/. 26.
WITNESS: Signature: (元) (本) (表) (表) (表) (表) (表) (表) (表) (表) (表) (表	Date Signed: 2017 - 1-26
FOR DONGGUAN HAILEX POLYMER MAT LTD:	ERIAL SCIENCE AND TECHNOLOGY CO
Signature: 14 15 15 15 15 15 15 15 15 15 15 15 15 15	Date Signed: 20>> 1. >4

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